

Octal channel high side driver

Features

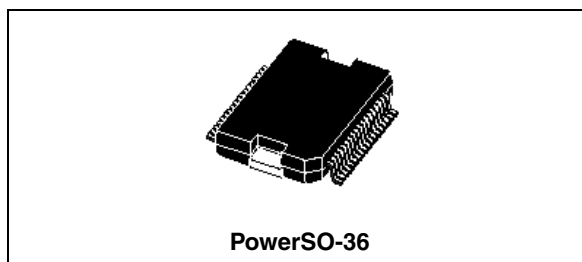
Type	$R_{DS(on)}^{(1)}$	$I_{out}^{(1)}$	V_{CC}
VN808-E	150 mΩ	0.7 A	45 V

1. Per channel

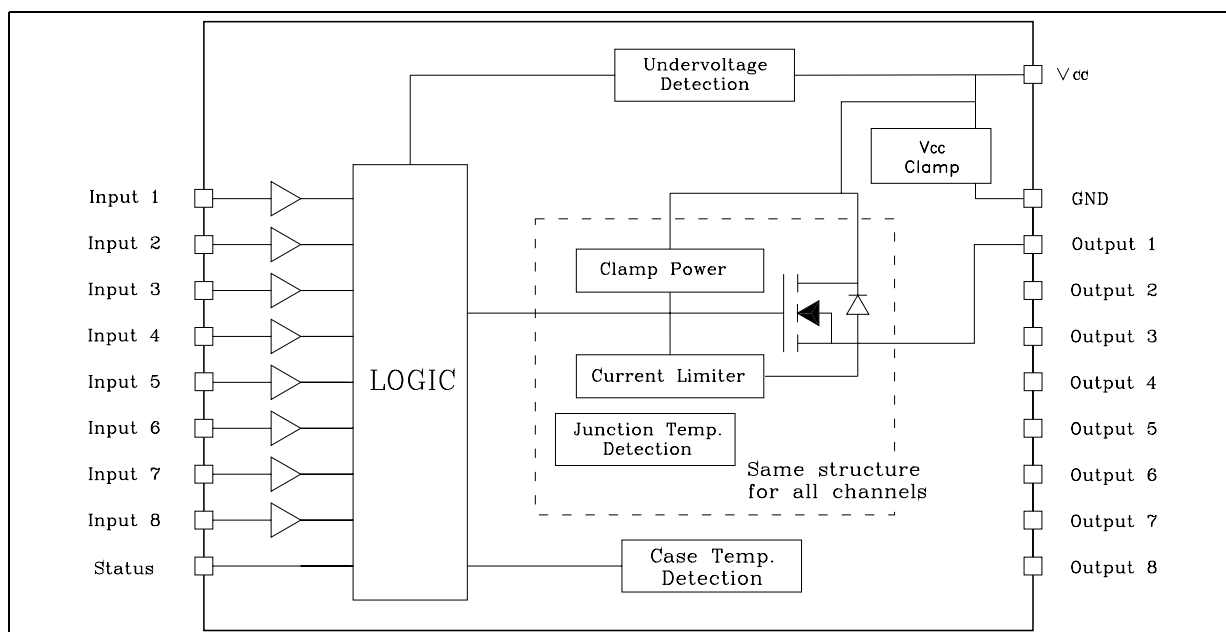
- $V_{CC}/2$ compatible input
- Junction overtemperature protection
- Case overtemperature protection for thermal independence of the channels
- Current limitation
- Shorted load protection
- Undervoltage shut-down
- Protection against loss of ground
- Very low stand-by current
- Compliance to 61000-4-4 IEC test up to 4 kV

Description

The VN808-E is a monolithic device designed in STMicroelectronics VIPower M0-3 technology, intended for driving any kind of load with one side connected to ground.



Active current limitation combined with thermal shutdown and automatic restart, protect the device against overload. In overload condition, channel turns OFF and back ON automatically so as to maintain junction temperature between T_{TSD} and T_R . If this condition makes case temperature reach T_{CSD} , overloaded channel is turned OFF and will restart only when case temperature has decreased down to T_{CR} (see waveform 3 [Figure 8 on page 11](#)). Non overloaded channels continue to operate normally. Device automatically turns OFF in case of ground pin disconnection. This device is especially suitable for industrial applications conform to IEC 61131



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1 Maximum ratings

Table 1. Absolute maximum rating

Symbol	Parameter	Value	Unit
V_{CC}	DC supply voltage	45	V
$-I_{GND}$	DC ground pin reverse current TRAN ground pin reverse current (pulse duration < 1ms)	-250 -6	mA A
I_{OUT}	DC output current	Internally limited	A
$-I_{OUT}$	Reverse DC output current	-2	A
I_{IN}	DC input current	± 10	mA
V_{IN}	Input voltage range	$-3/+V_{CC}$	V
V_{ESD}	Electrostatic discharge (R = 1.5 k Ω , C = 100 pF)	2000	V
P_{TOT}	Power dissipation at $T_C = 25\text{ }^\circ\text{C}$	96	W
L_{MAX}	Max inductive load ($V_{CC} = 24\text{ V}$, $R_{LOAD} = 48\text{ }\Omega$, $T_A = 100\text{ }^\circ\text{C}$)	2	H
T_J	Junction operating temperature	Internally limited	$^\circ\text{C}$
T_C	Case operating temperature	Internally limited	$^\circ\text{C}$
T_{STG}	Storage temperature	-40 to 150	$^\circ\text{C}$

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R_{thJC}	Thermal resistance junction-case	Max 1.3	$^\circ\text{C}/\text{W}$
R_{thJA}	Thermal resistance junction-ambient ⁽¹⁾	Max 50	$^\circ\text{C}/\text{W}$

1. When mounted on FR4 printed circuit board with 0.5 cm² of copper area (at least 35 μm thick) connected to all TAB pins.

2 Electrical characteristics

(10.5 V < V_{CC} < 32 V; -40 °C < T_J < 125 °C; unless otherwise specified)

Table 3. Power section

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
V _{CC}	Operating supply voltage		10.5		45	V
V _{USD}	Undervoltage shutdown		7		10.5	V
R _{ON}	On state resistance	I _{OUT} = 0.5 A; T _J = 25 °C I _{OUT} = 0.5 A;		150	185 280	mΩ mΩ
I _S	Supply current	OFF state; V _{CC} = 24 V; T _{CASE} = 25 °C ON state (all channels ON); V _{CC} = 24 V, T _{CASE} = 100 °C			150 12	μA mA
I _{LGND}	Output current at turn-off	V _{CC} = V _{STAT} = V _{IN} = V _{GND} = 24 V V _{OUT} = 0 V			1	mA
I _{L(off)}	OFF state output current	V _{IN} = V _{OUT} = 0 V;	0		5	μA
V _{OUT(off)}	OFF state output voltage	V _{IN} = 0 V, I _{OUT} = 0 A			3	V
t _{d(V_{CC}con)}	Power-on delay time from V _{CC} rising edge	<i>Figure 7 on page 10</i>		1		ms

Table 4. Switching (V_{CC} = 24 V)

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
t _{ON}	Turn-on time	R _L = 48 Ω from 80 % V _{OUT} <i>Figure 6</i> .		50	100	μs
t _{OFF}	Turn-off time	R _L = 48 Ω to 10 % V _{OUT} <i>Figure 6</i> .		75	150	μs
dV _{OUT} /dt _(on)	Turn-on voltage slope	R _L = 48 Ω from V _{OUT} = 2.4 V to V _{OUT} = 19.2 V <i>Figure 6</i> .		0.7		V/μs
dV _{OUT} /dt _(off)	Turn-off voltage slope	R _L = 48 Ω from V _{OUT} = 21.6 V to V _{OUT} = 2.4 V <i>Figure 6</i> .		1.5		V/μs

Table 5. Input pin

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
V_{INL}	Input low level				$V_{CC}/2-1$	V
I_{INL}	Low level input current	$V_{IN} = V_{CC} / 2 - 1 \text{ V}$	80			μA
V_{INH}	Input high level		$V_{CC}/2+1$			V
I_{INH}	High level input current	$V_{IN} = V_{CC} / 2 + 1 \text{ V}$		150	260	μA
$V_{I(HYST)}$	Input hysteresis voltage			0.6		V
I_{IN}	Input current	$V_{IN} = V_{CC} = 32 \text{ V}$			300	μA

Table 6. Protections

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
T_{CSD}	Case shut-down temperature		125	130	135	$^{\circ}\text{C}$
T_{CR}	Case reset temperature		110			$^{\circ}\text{C}$
T_{CHYST}	Case thermal hysteresis		7	15		$^{\circ}\text{C}$
T_{TSD}	Junction shutdown temperature		150	175	200	$^{\circ}\text{C}$
T_R	Junction reset temperature		135			$^{\circ}\text{C}$
T_{HYST}	Junction thermal hysteresis		7	15		$^{\circ}\text{C}$
I_{lim}	DC short circuit current per channel	$V_{CC} = 24 \text{ V}; R_{LOAD} = 10 \text{ m}\Omega$	0.7		1.7	A
V_{demag}	Turn-off output clamp voltage	$I_{OUT} = 0.5 \text{ A}; L = 6 \text{ mH}$	$V_{CC}-57$	$V_{CC}-52$	$V_{CC}-47$	V

Table 7. Status pin

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
I_{HSTAT}	High level output current	$V_{CC} = 18...32 \text{ V}; R_{STAT} = 1 \text{ k}\Omega$ (Fault condition)	2	3	4	mA
I_{LSTAT}	Leakage current	Normal operation; $V_{CC} = 32 \text{ V}$			0.1	μA
V_{CLSTAT}	Clamp voltage	$I_{STAT} = 1 \text{ mA}$ $I_{STAT} = -1 \text{ mA}$	6.0	6.8 -0.7	8.0	V V

3 Pin connections

Figure 2. Connection diagram (top view)

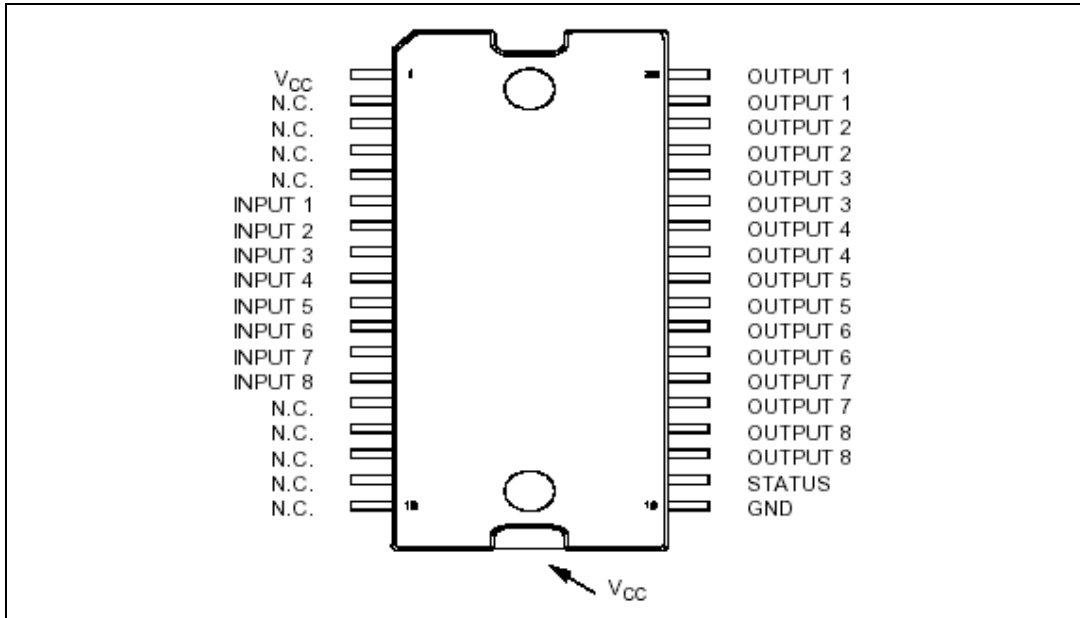


Table 8. Pin functions

Pin N°	Symbol	Function
TAB	V _{CC}	Positive power supply voltage
1	V _{CC}	Positive power supply voltage
2,3,4,5	NC	Not connected
6	Input 1	Input of channel 1
7	Input 2	Input of channel 2
8	Input 3	Input of channel 3
9	Input 4	Input of channel 4
10	Input 5	Input of channel 5
11	Input 6	Input of channel 6
12	Input 7	Input of channel 7
13	Input 8	Input of channel 8
14,15,16,17,18	NC	Not connected
19	GND	Logic ground
20	STATUS	Common open source diagnostic for overtemperature
21,22	Output 8	High-side output of channel 8
23,24	Output 7	High-side output of channel 7
25, 26	Output 6	High-side output of channel 6

Table 8. Pin functions (continued)

Pin N°	Symbol	Function
27, 28	Output 5	High-side output of channel 5
29, 30	Output 4	High-side output of channel 4
31, 32	Output 3	High-side output of channel 3
33, 34	Output 2	High-side output of channel 2
35, 36	Output 1	High-side output of channel 1

4 Current, voltage conventions and internal diagram

Figure 3. Current and voltage conventions

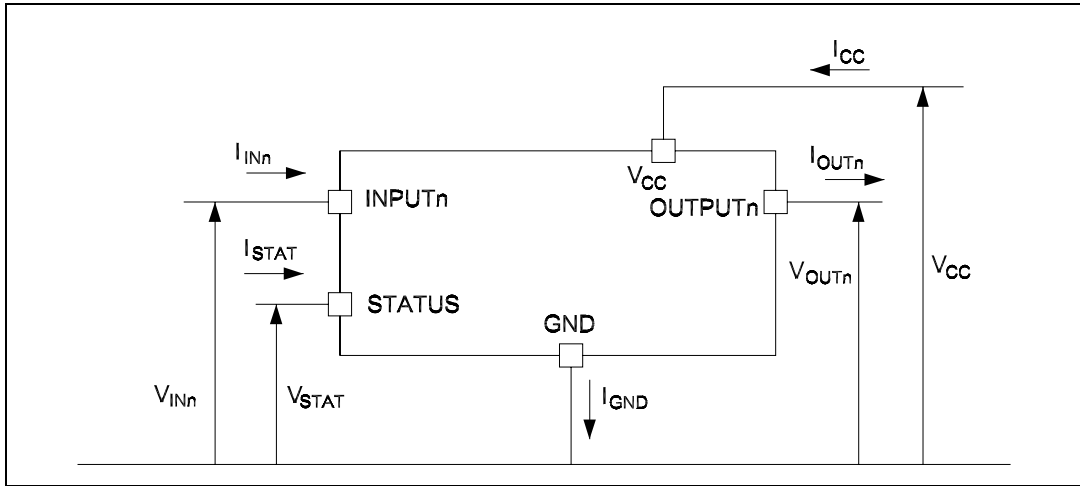


Figure 4. Equivalent internal block diagram (same structure for all channel)

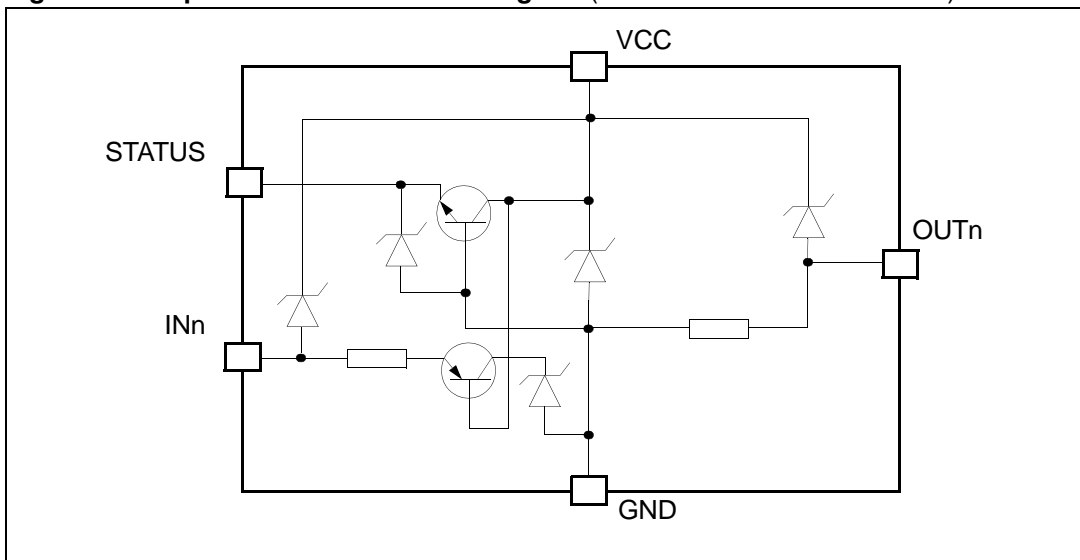


Figure 5. Application example

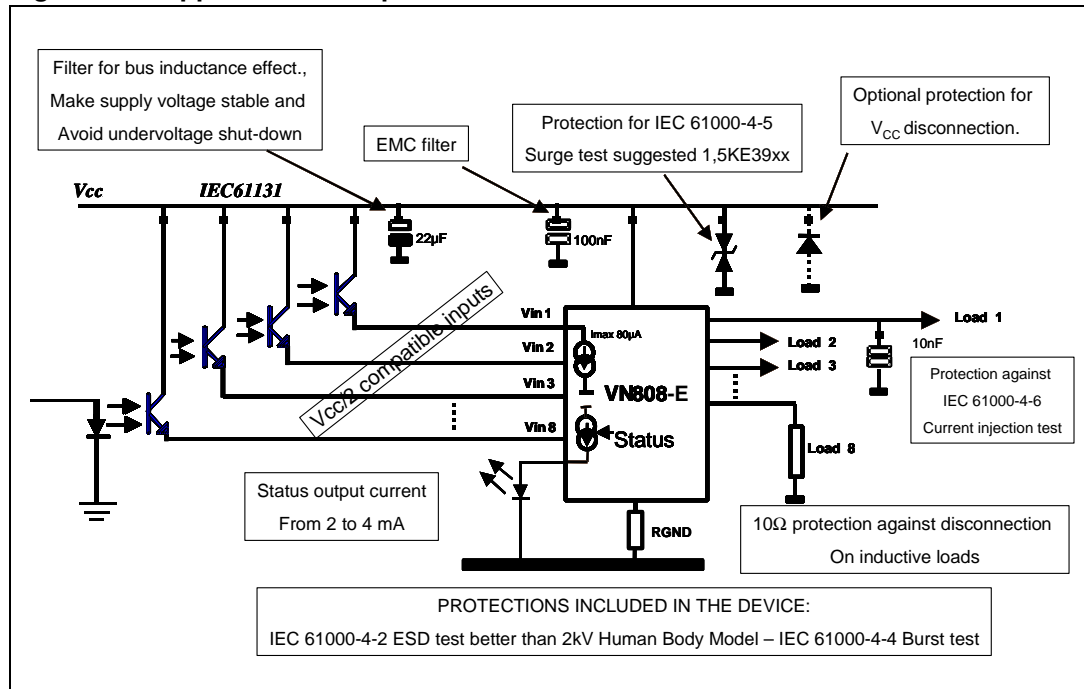


Table 9. Truth table

Conditions	INPUTn	OUTPUTn	STATUS
Normal operation	L H	L H	L L
Current limitation	L H	L X	L L
Overtemperature (see waveforms 3, 4 Figure 8) -> $T_J > T_{TSD}$	L H	L L	L H
Undervoltage	L H	L L	X X

5 Switching time waveforms

Figure 6. Turn-ON and turn-OFF

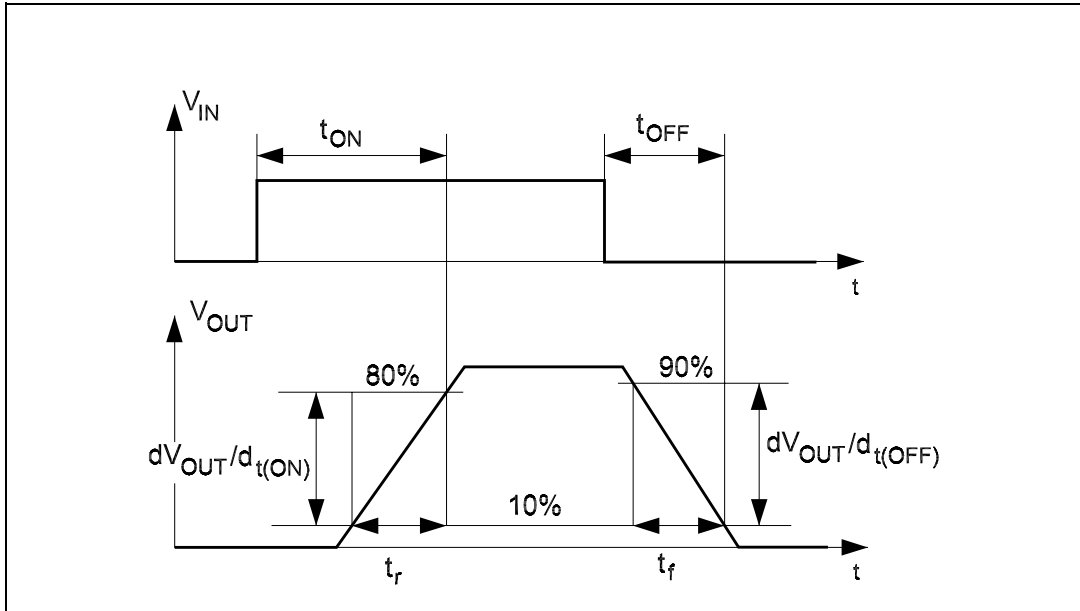


Figure 7. V_{CC} turn-ON

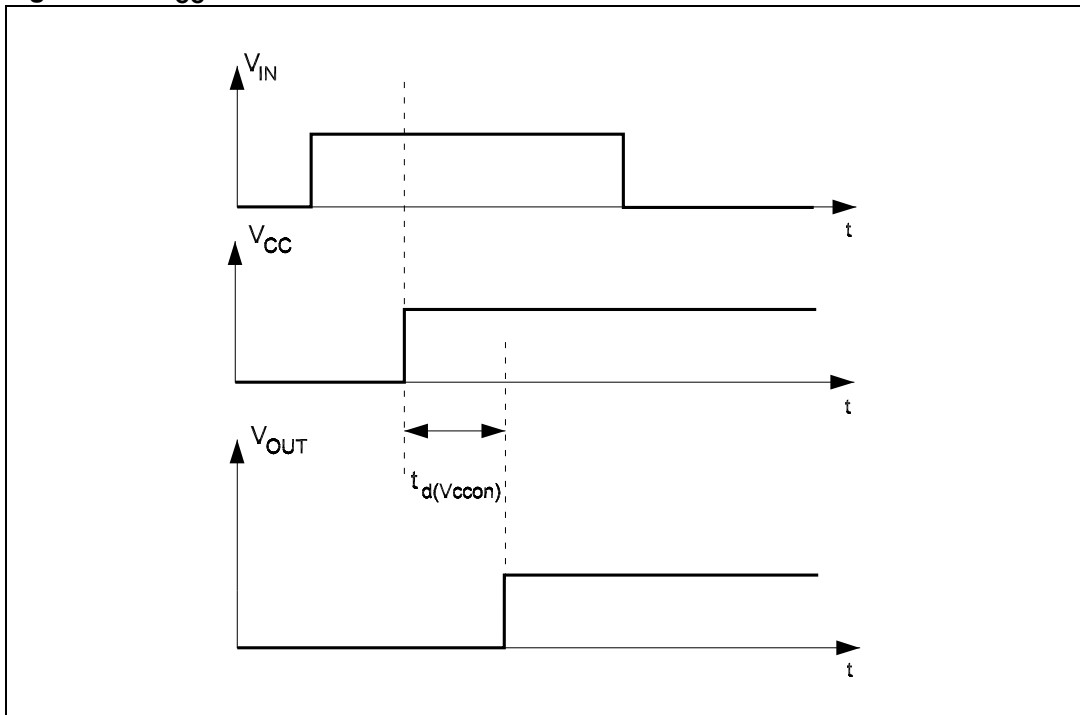


Figure 8. Waveforms

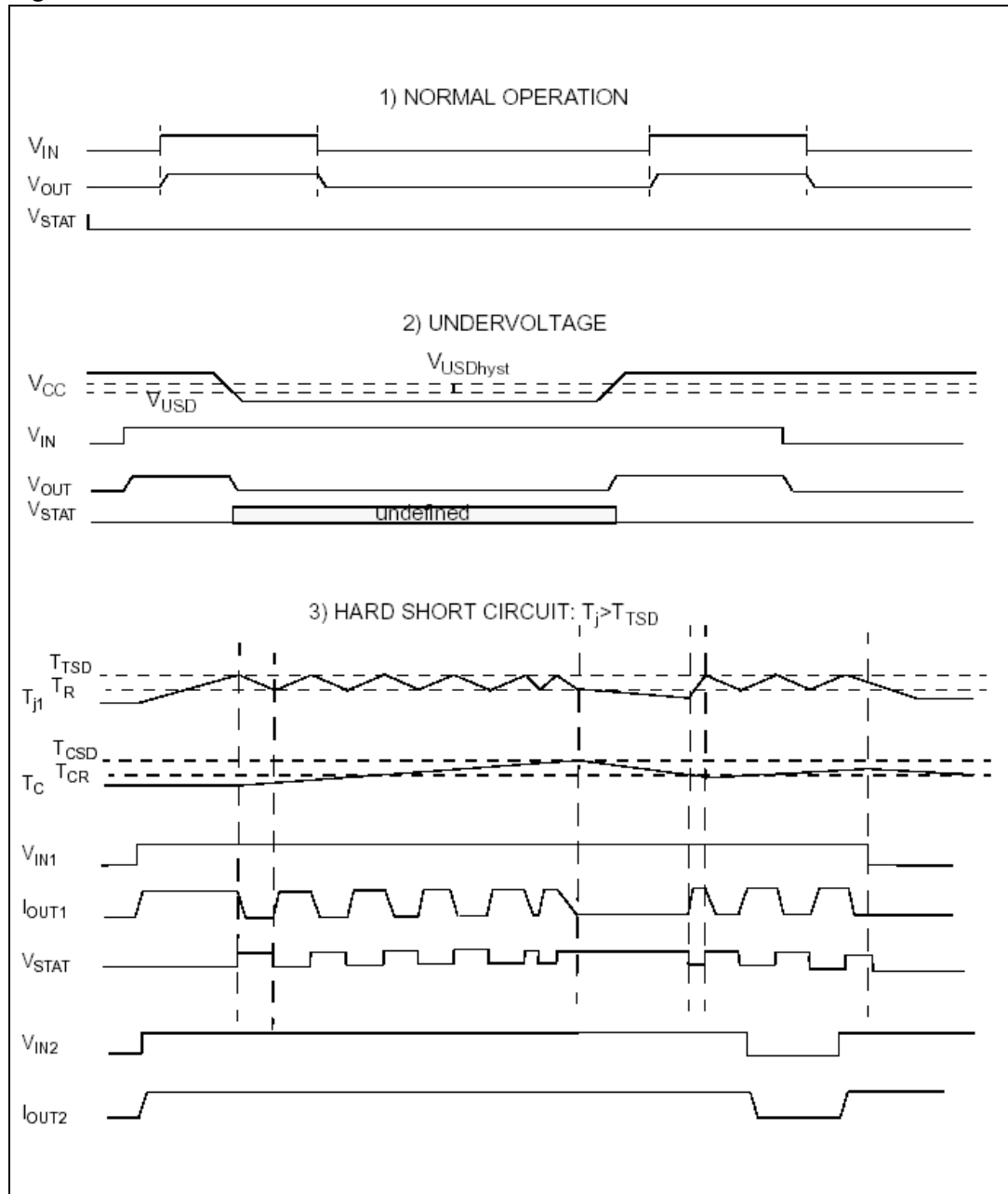
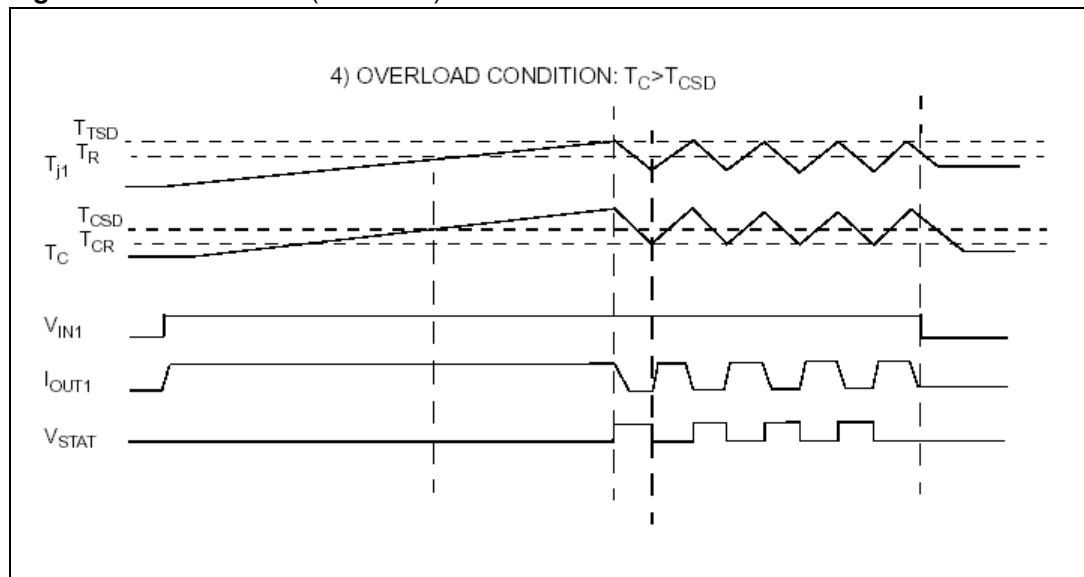


Figure 8. Waveforms (continued)



6 Reverse polarity protection

This schematic can be used with any type of load.

The following is an indication on how to dimension the R_{GND} resistor.

$$R_{GND} = (-V_{CC}) / (-I_{GND})$$

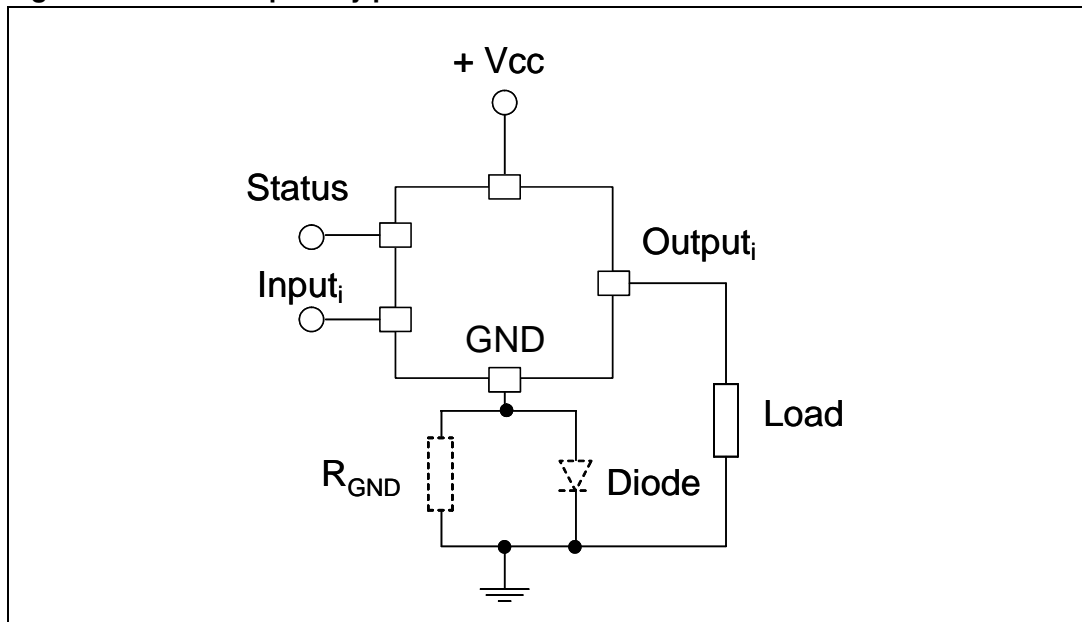
where $-I_{GND}$ is the DC reverse ground pin current and can be found in the absolute maximum rating section of the device datasheet.

Power dissipation in R_{GND} (when $V_{CC} < 0$: during reverse polarity situations) is:

$$PD = (-V_{CC})^2 / R_{GND}$$

Note: In normal condition (no reverse polarity) due to the diode there will be a voltage drop between GND of the device and GND of the system.

Figure 9. Reverse polarity protection



7 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Table 10. PowerSO-36 mechanical data

Dim.	mm			inch		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			3.60			0.1417
a1	0.10		0.30	0.003		0.0118
a2			3.30			0.1299
a3	0		0.10	0		0.0039
b	0.22		0.38	0.008		0.0150
c	0.23		0.32	0.009		0.0126
D (1)	15.80		16.00	0.622		0.6299
D1	9.40		9.80	0.370		0.3858
E	13.90		14.50	0.547		0.5709
E1 (1)	10.90		11.10	0.429		0.4370
E2			2.90			0.1142
E3	5.8		6.2	0.228		0.2441
e		0.65			0.025	
e3		11.05			0.435	
G	0		0.10	0.000		0.0039
H	15.50		15.90	0.610		0.6260
h			1.10			0.0433
L	0.80		1.10	0.031		0.0433
N			10°			10°
S	0°		8°	0°		8°

Figure 10. PowerSO-36 drawings

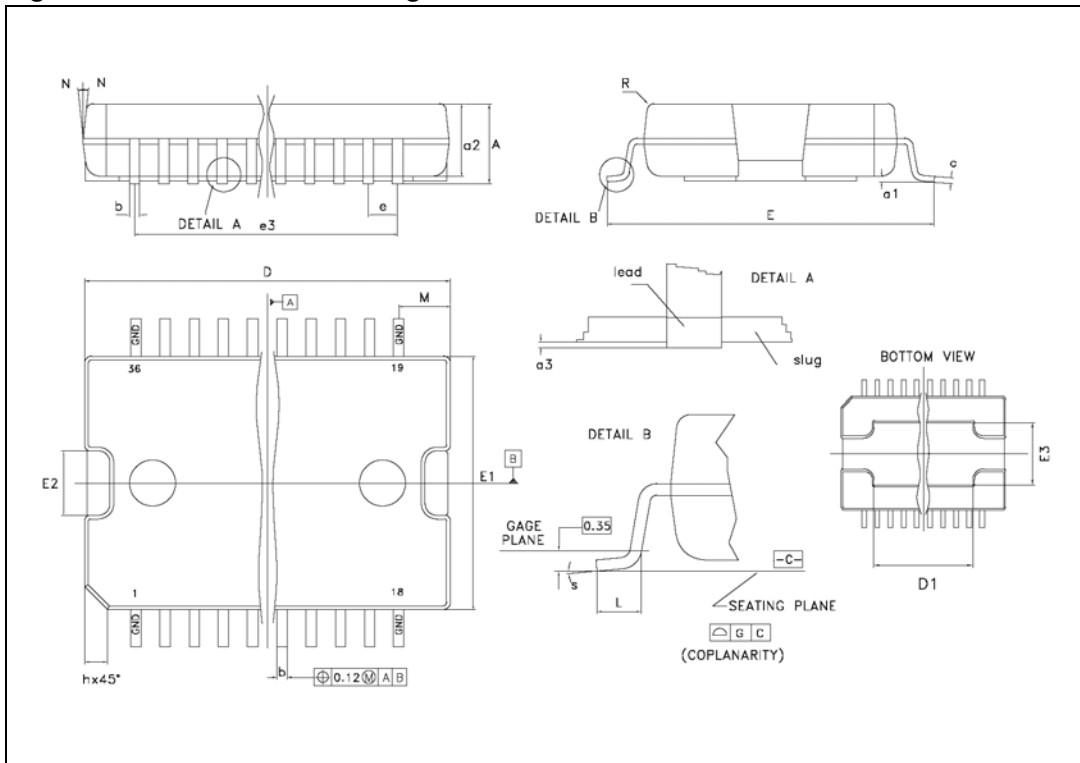
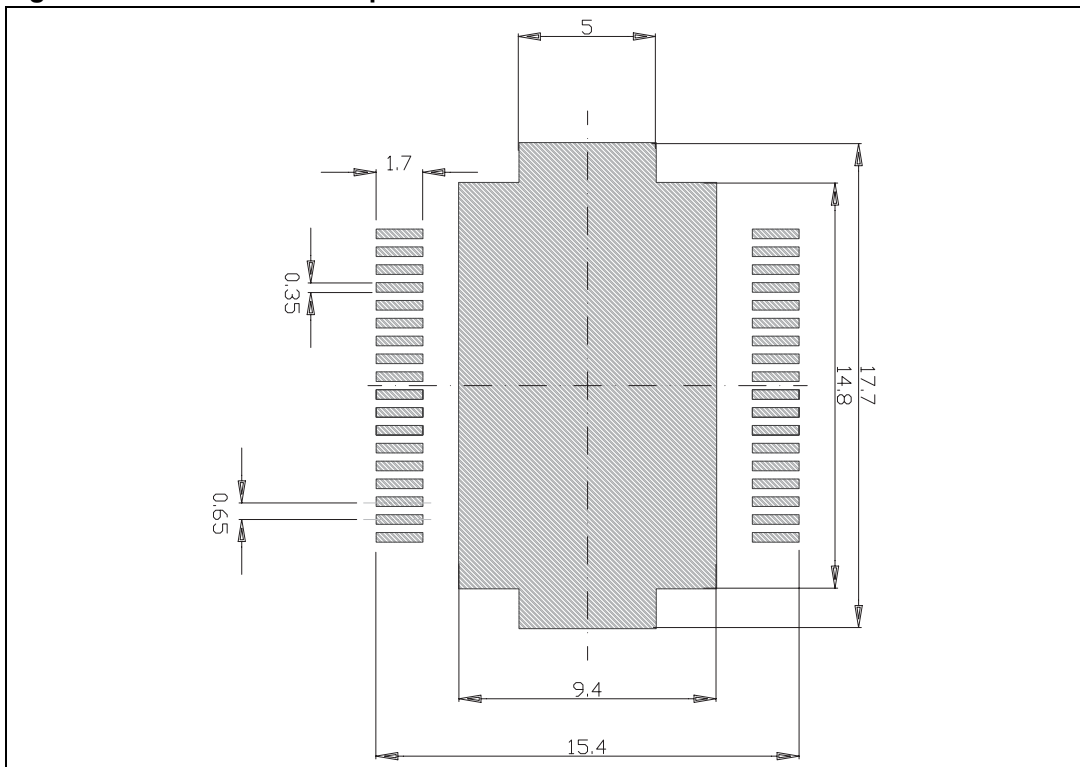


Figure 11. PowerSO-36 footprint



8 Order codes

Table 11. Order codes

Order codes	Package	Packaging
VN808-E	PowerSO-36	Tube
VN808TR-E	PowerSO-36	Tape and reel

9 Revision history

Table 12. Document revision history

Date	Revision	Changes
13-Sep-2005	1	Initial release
1-Mar-2007	2	Document reformatted
12-Mar-2007	3	Typo in Figure 3 .
26-Mar-2007	4	Typo note Table 2 .
07-Jul-2008	5	Added: Section 6 on page 13
04-Aug-2008	6	Added: Figure 11: PowerSO-36 footprint on page 15
25-Aug-2009	7	Updated Section 6: Reverse polarity protection

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